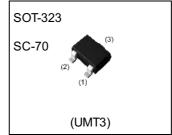


### PNP -100mA -50V Digital Transistor (Bias Resistor Built-in Transistor)

| Parameter        | Value  |  |
|------------------|--------|--|
| V <sub>CEO</sub> | -50V   |  |
| I <sub>C</sub>   | -100mA |  |
| R                | 47kΩ   |  |

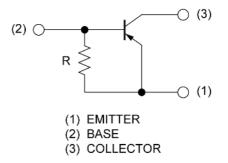
### Outline



#### Features

- 1) Built-In Biasing Resistors, R =  $47k\Omega$
- 2) Complementary NPN Types: DTC144GUA

#### •Inner circuit



### Application

INVERTER, INTERFACE, DRIVER

### Packaging specifications

| Part No.  | Package           | Package<br>size | Taping<br>code | Reel size<br>(mm) | Tape width<br>(mm) | Basic<br>ordering<br>unit.(pcs) | Marking |
|-----------|-------------------|-----------------|----------------|-------------------|--------------------|---------------------------------|---------|
| DTA144GUA | SOT-323<br>(UMT3) | 2021            | T106           | 180               | 8                  | 3000                            | K16     |

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

| Parameter                    | Symbol            | Values      | Unit |
|------------------------------|-------------------|-------------|------|
| Collector-base voltage       | $V_{CBO}$         | -50         | V    |
| Collector-emitter voltage    | V <sub>CEO</sub>  | -50         | V    |
| Emitter-base voltage         | V <sub>EBO</sub>  | -5          | V    |
| Collector current            | I <sub>C</sub>    | -100        | mA   |
| Power dissipation            | P <sub>D</sub> *1 | 200         | mW   |
| Junction temperature         | T <sub>j</sub>    | 150         | °C   |
| Range of storage temperature | T <sub>stg</sub>  | -55 to +150 | °C   |

# ● Electrical characteristics (T<sub>a</sub> = 25°C)

| Danamastan                           | Cymah ol             | Conditions  | Values |      |      | 1.114 |  |
|--------------------------------------|----------------------|---|--------|------|------|-------|--|
| Parameter                            | Symbol               | Conditions  | Min.   | Тур. | Max. | Unit  |  |
| Collector-base breakdown voltage     | BV <sub>CBO</sub>    | I <sub>C</sub> = -50μA                                      | -50    | -    | -    | V     |  |
| Collector-emitter breakdown voltage  | BV <sub>CEO</sub>    | I <sub>C</sub> = -1mA                                       | -50    | -    | -    | V     |  |
| Emitter-base breakdown voltage       | BV <sub>EBO</sub>    | I <sub>E</sub> = -160μA                                     | -5     | -    | -    | V     |  |
| Collector cut-off current            | I <sub>CBO</sub>     | V <sub>CB</sub> = -50V                                      | -      | -    | -500 | nA    |  |
| Emitter cut-off current              | I <sub>EBO</sub>     | V <sub>EB</sub> = -4V                                       | -65    | -    | -130 | μA    |  |
| Collector-emitter saturation voltage | V <sub>CE(sat)</sub> | I <sub>C</sub> = -10mA, I <sub>B</sub> = -0.5mA             | -      | -    | -300 | mV    |  |
| DC current gain                      | $h_{FE}$             | $V_{CE} = -5V$ , $I_{C} = -5mA$                             | 68     | -    | -    | -     |  |
| Emitter-base resistance              | R                    | -   | 32.9   | 47   | 61.1 | kΩ    |  |
| Transition frequency                 | f <sub>T</sub> *2    | V <sub>CE</sub> = -10V, I <sub>E</sub> = 5mA,<br>f = 100MHz | -      | 250  | -    | MHz   |  |

<sup>\*1</sup> Each terminal mounted on a reference land.

<sup>\*2</sup> Characteristics of built-in transistor

### ● Electrical characteristic curves (T<sub>a</sub> =25°C)

Fig.1 Grounded emitter propagation characteristics

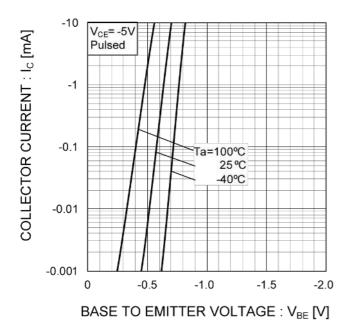
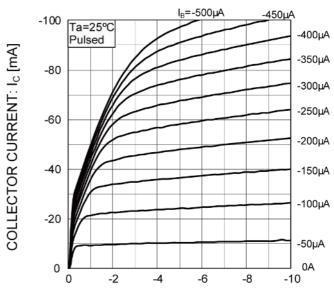


Fig.2 Grounded emitter output characteristics



COLLECTOR TO EMITTER VOLTAGE: VCE [V]

Fig.3 DC Current gain vs. Collector Current

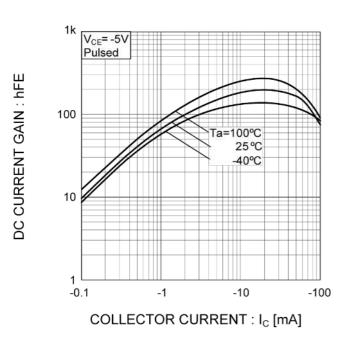
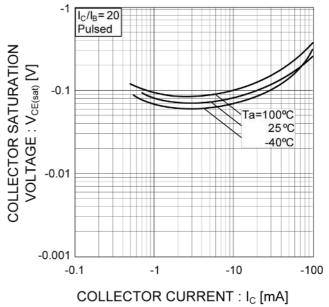
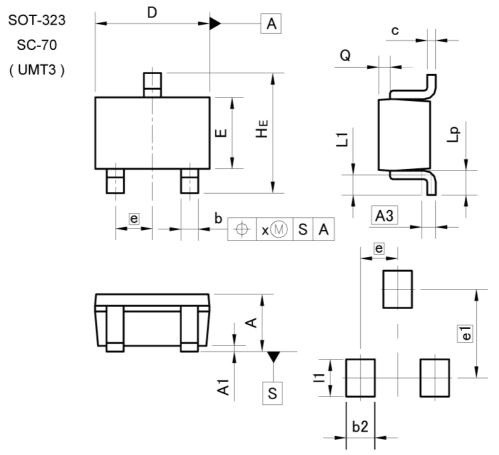


Fig.4 Collector-emitter saturation voltage vs. Collector Current



### Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

| DIM - | MILIME | TERS | INCHES |       |  |
|-------|--------|------|--------|-------|--|
| DIM L | MIN    | MAX  | MIN    | MAX   |  |
| Α     | 0.80   | 1.00 | 0.031  | 0.039 |  |
| A1    | 0.00   | 0.10 | 0.000  | 0.004 |  |
| A3    | 0.2    | 5    | 0.0    | 10    |  |
| b     | 0.25   | 0.40 | 0.010  | 0.016 |  |
| С     | 0.10   | 0.20 | 0.004  | 0.008 |  |
| D     | 1.90   | 2.10 | 0.075  | 0.083 |  |
| E     | 1.15   | 1.35 | 0.045  | 0.053 |  |
| е     | 0.6    | 5    | 0.026  |       |  |
| HE    | 2.00   | 2.20 | 0.079  | 0.087 |  |
| L1    | 0.10   | 0.40 | 0.004  | 0.016 |  |
| Lp    | 0.25   | 0.55 | 0.010  | 0.022 |  |
| Q     | 0.10   | 0.30 | 0.004  | 0.012 |  |
| х     | -      | 0.10 | -      | 0.004 |  |

| DIM | MILIME | TERS | INCHES         |       |  |
|-----|--------|------|----------------|-------|--|
| DIM | MIN    | MAX  | MIN            | MAX   |  |
| b2  | 22     | 0.50 | ( <u>3022)</u> | 0.020 |  |
| e1  | 1.55   |      | 0.0            | 61    |  |
| 11  | -      | 0.65 | -              | 0.026 |  |

Dimension in mm/inches



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| JAPAN   | USA       | EU       | CHINA    |
|---------|-----------|----------|----------|
| CLASSⅢ  | CL ACCIII | CLASSIIb | CL ACCTI |
| CLASSIV | CLASSII   | CLASSⅢ   | CLASSIII |

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  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- 8. Confirm that operation temperature is within the specified range described in the product specification.
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  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
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